

**PRELIMINARY AMENDMENT**

Serial Number: Unknown

Filing Date: Herewith

Title: METHOD FOR ATTACHING A SEMICONDUCTOR DIE TO A SUBSTRATE

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Dkt: 303.527US2

The Applicant respectfully requests that the preliminary amendment described herein be entered into the record prior to examination and consideration of the above-identified application.

Respectfully submitted,

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By their Representatives,

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Date of Deposit: August 29, 2000

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